

SB3200

Technical Data Data Sheet N0091, Rev.A RoHS 🗭

SB3200 SCHOTTKY RECTIFIER



Features

- Schottky Barrier Chip
- Guard Ring Die Construction for Transient Protection
- High Current Capability
- Low Power Loss, High Efficiency
- High Surge Current Capability
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Terminals finish: 100% Pure Tin
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Disk drives
- Battery charging

Maximum Ratings:

| Characteristics | Symbol | Condition | Max. | Units |
|--|--------------------------------|---|------|-------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | Vrrm V _{rwm} Vr | - | 200 | V |
| Average Rectified Forward Current | I _{F (AV)} | 50% duty cycle @T _A =25°C, rectangular wave form | 3 | А |
| Peak One Cycle Non-Repetitive Surge Current | I _{FSM} | 8.3 ms, half Sine pulse, T_C =25°C | 80 | A |

Electrical Characteristics:

| Characteristics | Symbol | Condition | Тур. | Max. | Units |
|------------------------|-----------------|---|--------|------|-------|
| Forward Voltage Drop* | V _{F1} | @ 3A, Pulse, T _J = 25 °C | 0.81 | 0.90 | V |
| | V _{F2} | @ 3A, Pulse, T _J = 125 °C | 0.68 | 0.75 | V |
| Reverse Current* | I _{R1} | $@V_R$ = Rated V _R , Pulse, T _J = 25 °C | 0.0001 | 1.0 | mA |
| | I _{R2} | $@V_R$ = Rated V _R , Pulse, T _J = 125 °C | 0.04 | 6 | mA |
| Junction Capacitance | Ст | @V _R = 5V, T _C = 25 °C f _{SIG} = 1MHz | 130 | 150 | pF |
| Voltage Rate of Change | dv/dt | 10,000 | | V/μs | |

* Pulse width < 300 μs, duty cycle < 2%

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Circuit Diagram





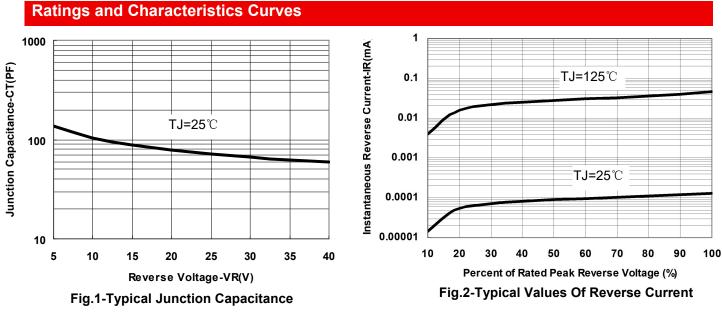
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Thermal-Mechanical Specifications:

| Characteristics | Symbol | Condition | Specification | Units |
|---|------------------|--------------|---------------|-------|
| Junction Temperature | TJ | - | -55 to +150 | °C |
| Storage Temperature | T _{stg} | - | -55 to +150 | °C |
| Typical Thermal Resistance Junction to Ambient | $R_{	heta JA}$ | DC operation | 25 | °C/W |
| Approximate Weight | wt | - | 1.02 | g |



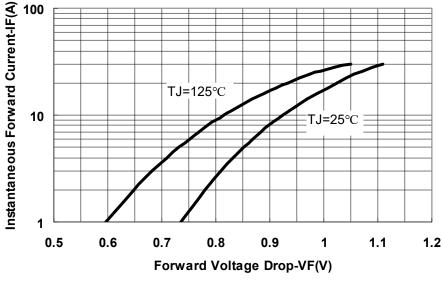


Fig.3-Typical Forward Voltage Drop Characteristics

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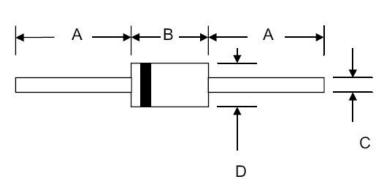


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Mechanical Dimensions DO-201AD



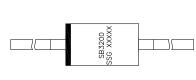
| OVMDOL | Millim | neters | Inches | |
|--------|--------|--------|--------|-------|
| SYMBOL | Min. | Max. | Min. | Max. |
| А | 25.4 | - | 1.000 | - |
| В | 8.50 | 9.50 | 0.335 | 0.374 |
| С | 1.2 | 1.3 | 0.048 | 0.052 |
| D | 5.0 | 5.6 | 0.197 | 0.220 |

Ordering Information

| Device | Package | Shipping | |
|--------|-----------|----------------|--|
| SB3200 | DO-201AD | 1250pcs / tape | |
| | (Pb-Free) | | |

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram



Where XXXXX is YYWWL

SSG YY

ww

L

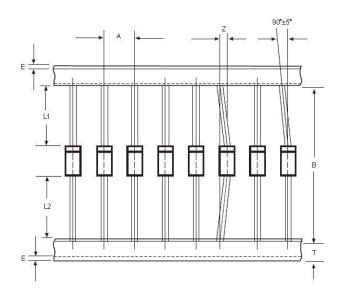
- SB3200 = Part Name
 - = SSG
 - = Year

= Week

= Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

Carrier Tape Specification DO-201AD



| SYMBOL | Millimeters | | |
|---------|-------------|-------|--|
| | Min. | Max. | |
| A | 9.50 | 10.50 | |
| В | 50.9 | 53.9 | |
| Z | - | 1.20 | |
| Т | 5.60 | 6.40 | |
| E | - | 0.80 | |
| IL1-L2I | - | 1.0 | |



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